### **FEATURES AND BENEFITS**



Mini-Fit RTCTM (Reflow Temperature Compatible) vertical and right-angle headers achieve reflow-solder temperatures up to 265°C for lead-free processes and mate with standard Mini-Fit® receptacles

Designed with a high-temperature LCP housing, Mini-Fit Reflow Temperature Compatible (RTC) headers can withstand solder-reflow temperatures up to 265°C, to guarantee compatibility with lead-free reflow processes. Mini-Fit RTC™ headers provide a solution for applications with high-temperature reflow soldering requirements.

Mini-Fit RTC headers mate with standard Mini-Fit® receptacles and incorporate the standard Mini-Fit polarization design. Mini-Fit RTC headers share the same design features of the Mini-Fit Jr. headers, ensuring compatibility and reliability.

Mini-Fit products provide a cost-effective solution for mid-range power applications that require high-density and higher currentcarrying capability.

For more information on Molex's extensive Mini-Fit product offering, visit www.molex.com/product/minifit.html

#### **Features and Benefits**

- High-temperature LCP housing withstands RoHS lead-free processing up to +265°C peak
- Optional press-fit PCB pegs provide polarization during placement on the PCB and increased retention during the soldering process (vertical headers only); pegs can be subjected to +265°C wave-solder process without deformation
- High-current Mini-fit Plus HCS™ male pins provide up to 13.0A per circuit (mated with Mini-Fit Plus HCS™ female crimp terminal. 16AWG)
- Mini-Fit locking thumb latch assures positive locking of mating connectors
- Standard Mini-Fit polarized, keyed silos prevent mismatching and provides protection for the mating terminals; compatible with existing Mini-Fit receptacles
- Circuit sizes 4 to 12, and 24 in vertical and right-anlge options provide design flexibility
- Matte tin plating can be used in higher temperature soldering environments versus bright tin plating

#### Reference Information

Packaging: Tray

Mates With: 5557 Receptacle Designed In: Millimeters

Process: Wave Solder or Reflow, 265°C peak

## **Electrical**

Voltage: 600V Current: 13.0A

Contact Resistance: 20 milliohms
Dielectric Withstanding Voltage: 2200V AC
Insulation Resistance: 1000 Meaohms min.

#### Mechanical

Mating Cycles: 30 cycles

## **Physical**

Housing: LCP, black Flammability: UL 94V-0 Contact: Brass

Plating: Matte Tin over Nickel Tail Lengths:

3.66mm (.144") 4.46mm (.176") 5.26mm (.207")

Operating Temperature: -40 to +105°C Lead-free Process Capable: Yes

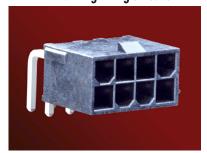
# Mini-Fit RTC<sup>™</sup> Reflow Temperature Compatible Headers 4.20mm (.165") Pitch

46207 Vertical Headers 46991 Right-Angle Headers

#### Mini-Fit RTC™ Vertical Header



Mini-Fit RTC™ Right-Angle Header



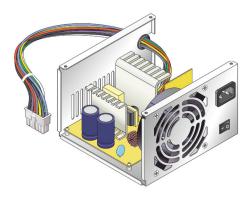


# **APPLICATIONS**

- Desktop/tower computer
- Power supplies
- Telecommunications
  - Hubs
  - Servers
- Industrial
- Medical
- Transportation
- Marine and recreational
- Military Commercial Off-the-Shelf (COTS)
- Mid-range power applications







**PC Power Supply** 

# **ORDERING INFORMATION**

*Order No.			
Circuits	Vertical Orientation  Tail Length = 3.66mm (.144")		Right-Angle Orientation
			Tail Length = 3.30mm (.130")
	With Pegs	Without Pegs	Without Pegs
4	46207-0004	46207-1004	46991-1004
6	46207-0006	46207-1006	46991-1006
8	46207-0008	46207-1008	46991-1008
10	46207-0010	46207-1010	46991-1010
12	46207-0012	46207-1012	46991-1012
24	46207-0024	46207-1024	46991-1024

<sup>\*</sup>For tape and reel packaging please contact Molex inside sales

